

NC7SB3157, FSA3157 Low Voltage SPDT Analog Switch or 2:1 Multiplexer/Demultiplexer Bus Switch

General Description

The NC7SB3157 or FSA3157 is a high performance, single-pole/double-throw (SPDT) Analog Switch or 2:1 Multiplexer/Demultiplexer Bus Switch. The device is fabricated with advanced sub-micron CMOS technology to achieve high speed enable and disable times and low On Resistance. The break before make select circuitry prevents disruption of signals on the B Port due to both switches temporarily being enabled during select pin switching. The device is specified to operate over the 1.65 to 5.5V $\rm V_{CC}$ operating range. The control input tolerates voltages up to 5.5V independent of the $\rm V_{CC}$ operating range.

Features

- Useful in both analog and digital applications
- Space saving SC70 6-lead surface mount package
- Ultra small MicroPak[™] Pb-Free leadless package
- Low On Resistance; < 10Ω on typ @ $3.3V V_{CC}$
- Broad V_{CC} operating range; 1.65V to 5.5V
- Rail-to-Rail signal handling
- Power down high impedance control input
- Overvoltage tolerance of control input to 7.0V
- Break before make enable circuitry
- 250 MHz, 3dB bandwidth

Ordering Information

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SB3157P6X	MAA06A	B7A	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7SB3157P6X_NL ¹	MAA06A	B7A	Pb-Free 6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7SB3157L6X	MAC06A	BB	Pb-Free 6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel
FSA3157P6X	MAA06A	B7A	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
FSA3157P6X_NL ¹	MAA06A	В7А	Pb-Free 6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
FSA3157L6X	MAC06A	BB	Pb-Free 6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

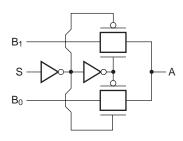
Pb-Free package per JEDEC J-STD-020B.

Note:

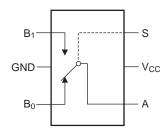
1. "_NL" indicates Pb-Free package (per JEDEC J-STD-020B). Device available in Tape and Reel only.

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

Logic Symbol



Analog Symbol



Function Table

Input (S)	Function
L	B ₀ Connected to A
Н	B ₁ Connected to A

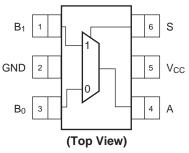
H = HIGH Logic Level L = LOW Logic Level

Pin Descriptions

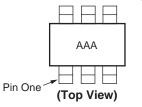
Pin Names Description			
A, B ₀ , B ₁	Data Ports		
S	Control Input		

Connection Diagrams

Pin Assignments for SC70



Pin One Orientation Diagram

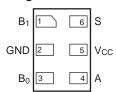


 $\ensuremath{\mathsf{AAA}} = \ensuremath{\mathsf{Product}}$ Code Top Mark , see Ordering Information.

Note:

Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Through View)

Absolute Maximum Ratings

(The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.)

Symbol	Parameter	Rating
V _{CC}	Supply Voltage ()	-0.5V to +7.0V
V _S	DC Switch Voltage ²	-0.5V to V _{CC} +0.5V
V _{IN}	DC Input Voltage ²	-0.5V to +7.0V
I _{IK}	DC Input Diode Current @ (I _{IK}) V _{IN} < 0V	–50 mA
I _{OUT}	DC Output Current	128 mA
I _{CC} /I _{GND}	DC V _{CC} or Ground Current	±100 mA
T _{STG}	Storage Temperature Range	−65°C to +150°C
TJ	Junction Temperature under Bias	150°C
T _L	Junction Lead Temperature (Soldering, 10 seconds)	260°C
P _D	Power Dissipation @ +85°C	180 mW
	ESD, Human Body Model	4000V

Recommended Operating Conditions³

Symbol	Parameter	Rating
V _{CC}	Supply Voltage Operating	1.65V to 5.5V
V _{IN}	Control Input Voltage	0V to V _{CC}
V _{IN}	Switch Input Voltage	0V to V _{CC}
V _{OUT}	Output Voltage	0V to V _{CC}
T _A	Operating Temperature	-40°C to +85°C
t _r , t _f	Input Rise and Fall Time	
	Control Input V _{CC} = 2.3V–3.6V	0 ns/V to 10 ns/V
	Control Input V _{CC} = 4.5V–5.5V	0 ns/V to 5 ns/V
θ_{JA}	Thermal Resistance	350°C/W

Notes:

- 2. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.
- 3. Control input must be held HIGH or LOW, it must not float.

DC Electrical Characteristics

				T,	₄ = +25°	°C	$T_A = -40^{\circ}$	C to +85°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Units
V _{IH}	HIGH Level		1.65 – 1.95	0.75 V _{CC}			0.75 V _{CC}		V
	Input Voltage		2.3 – 5.5	0.7 V _{CC}			0.7 V _{CC}		1
V _{IL}	LOW Level		1.65 – 1.95			0.25 V _{CC}		0.25 V _{CC}	V
	Input Voltage		2.3 – 5.5			0.3 V _{CC}		0.3 V _{CC}	1
I _{IN}	Input Leakage Current	$0 \le V_{IN} \le 5.5V$	0 – 5.5		±0.05	±0.1		±1	μA
l _{OFF}	OFF State Leakage Current	0 ≤ A, B ≤ V _{CC}	1.65 – 5.5		±0.05	±0.1		±1	μA
R _{ON}	Switch On	$V_{IN} = 0V, I_{O} = 30 \text{ mA}$	4.5		3.0	7.0		7.0	Ω
	Resistance ⁴	$V_{IN} = 2.4V$, $I_{O} = -30 \text{ mA}$			5.0	12.0		12.0	Ω
		$V_{IN} = 4.5V$, $I_{O} = -30 \text{ mA}$			7.0	15.0		15.0	Ω
		$V_{IN} = 0V$, $I_O = 24$ mA	3.0		4.0	9.0		9.0	Ω
		$V_{IN} = 3V, I_{O} = -24 \text{ mA}$			10.0	20.0		20.0	Ω
		$V_{IN} = 0V$, $I_O = 8 \text{ mA}$	2.3		5.0	12.0		12.0	Ω
		$V_{IN} = 2.3V$, $I_{O} = -8 \text{ mA}$			13.0	30.0		30.0	Ω
		$V_{IN} = 0V$, $I_O = 4$ mA	1.65		6.5	20.0		20.0	Ω
		$V_{IN} = 1.65V, I_{O} = -4 \text{ mA}$			17.0	50.0		50.0	Ω
I _{CC}	Quiescent Supply Current All Channels ON or OFF	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$	5.5			1		10	μА
	Analog Signal Range		V _{CC}	0		V _{CC}	0	V _{CC}	V
R _{RANGE}	On Resistance	$I_A = -30 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	4.5					25.0	Ω
	Over Signal Range ⁴ , ⁸	$I_A = -24 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	3.0					50.0	1
	range ,	$I_A = -8 \text{ mA}, 0 \le V_{Bn} \le V_{CC}$	2.3					100	1
		$I_A = -4 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	1.65					300	1
ΔR_{ON}	On Resistance	$I_A = -30 \text{ mA}, V_{Bn} = 3.15$	4.5		0.15				Ω
	Match Between Channels ⁴ , ^{5, 6}	$I_A = -24 \text{ mA}, V_{Bn} 2.1$	3.0		0.2				1
	Onamicis ,	$I_A = -8 \text{ mA}, V_{Bn} = 1.6$	2.3		0.5				1
		$I_A = -4 \text{ mA}, V_{Bn} = 1.15$	1.65		0.5				
R _{flat}	On Resistance	$I_A = -30 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	5.0		6.0				Ω
	Flatness ^{4, 5, 7}	$I_A = -24 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	3.3		12.0				
		$I_A = -8 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$	2.5		28.0				
		$I_A = -4 \text{ mA}, 0 \le V_{Bn} \le V_{CC}$	1.8		125				

Notes:

- 4. Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B Ports).
- 5. Parameter is characterized but not tested in production.
- 6. $\Delta R_{ON} = R_{ON} \text{ max} R_{ON} \text{ min measured at identical } V_{CC}$, temperature and voltage levels.
- 7. Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.
- 8. Guaranteed by Design.

AC Electrical Characteristics

			V _{CC}	T,	₄ = +25°	°C	$T_A = -40^\circ$	C to +85°C		Figure
Symbol	Parameter	Conditions	(V)	Min	Тур	Max	Min	Max	Units	Number
t _{PHL} ,	Propagation Delay	V _I = OPEN	1.65 – 1.95			3.5		3.5	ns	Figure 7
t _{PLH}	Bus to Bus ¹⁰		2.3 – 2.7			1.2		1.2		Figure 8
			3.0 – 3.6			0.8		0.8		
			4.5 – 5.5			0.3		0.3		
t _{PZL} ,	Output Enable Time	$V_I = 2 \times V_{CC}$ for t_{PZL}	1.65 – 1.95	7.0		23.0	7.0	24.0	ns	Figure 7
t _{PZH}	Turn on Time (A to B _n)	$V_I = 0V$ for t_{PZH}	2.3 – 2.7	3.5		13.0	3.5	14.0		Figure 8
	(A to D _n)		3.0 – 3.6	2.5		6.9	2.5	7.6		
			4.5 – 5.5	1.7		5.2	1.7	5.7		
t _{PLZ} ,	Output Disable Time	$V_I = 2 \times V_{CC}$ for t_{PLZ}	1.65 – 1.95	3.0		12.5	3.0	13.0	ns Figure 7	
t _{PHZ}	Turn Off Time (A Port to B Port)	$V_I = 0V$ for t_{PHZ}	2.3 – 2.7	2.0		7.0	2.0	7.5		Figure 8
			3.0 – 3.6	1.5		5.0	1.5	5.3		
			4.5 – 5.5	0.8		3.5	0.8	3.8		
t _{B-M}	Break Before Make Time ⁹		1.65 – 1.95	0.5			0.5		ns	Figure 9
			2.3 – 2.7	0.5			0.5			
			3.0 – 3.6	0.5			0.5			
			4.5 – 5.5	0.5			0.5			
Q	Charge Injection ⁹	$C_L = 0.1 \text{ nF, } V_{GEN} = 0V,$	5.0		7.0				рС	Figure 10
		$R_{GEN} = 0\Omega$	3.3		3.0					
OIRR	Off Isolation ¹¹	$R_L = 50\Omega$, $f = 10MHz$	1.65 – 5.5		-57.0				dB	Figure 11
Xtalk	Crosstalk	$R_L = 50\Omega$, $f = 10MHz$	1.65 – 5.5		-54.0				dB	Figure 12
BW	-3dB Bandwidth	$R_L = 50\Omega$	1.65 – 5.5		250				MHz	Figure 15
THD	Total Harmonic Distortion ⁹	$R_L = 600\Omega, 0.5 V_{P-P}$ f = 600 Hz to 20 KHz	5.0		.011				%	

Capacitance¹²

Symbol	Parameter	Тур	Max	Units	Conditions	Figure Number
C _{IN}	Control Pin Input Capacitance	2.3		pF	$V_{CC} = 0V$	
C _{IO-B}	B Port Off Capacitance	6.5		pF	$V_{CC} = 5.0V$	Figure 13
C _{IOA-ON}	A Port Capacitance When Switch Is Enabled	18.5		pF	V _{CC} = 5.0V	Figure 14

Notes:

- 9. Guaranteed by Design.
- 10. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).
- 11. Off Isolation = $20 \log_{10} [V_A / V_{Bn}]$
- 12. $T_A = +25$ °C, f = 1 MHz, Capacitance is characterized but not tested in production.

Typical Characteristics

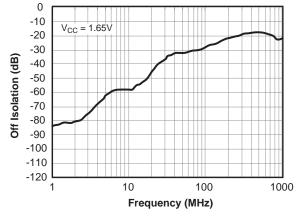


Figure 1. Off Isolation, $V_{CC} = 1.65V$

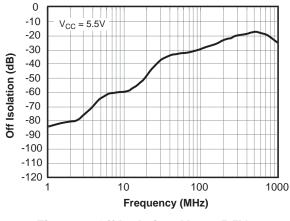


Figure 2. Off Isolation, $V_{CC} = 5.5V$

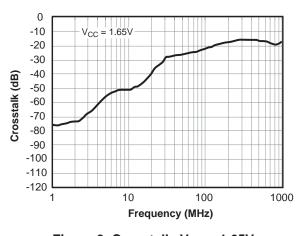


Figure 3. Crosstalk, $V_{CC} = 1.65V$

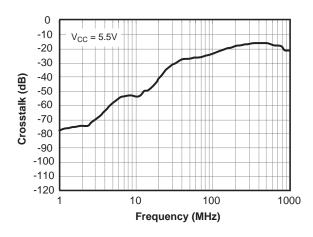


Figure 4. Crosstalk, $V_{CC} = 5.5V$

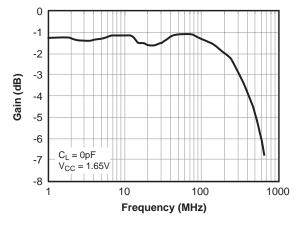


Figure 5. Bandwidth, V_{CC} = 1.65V

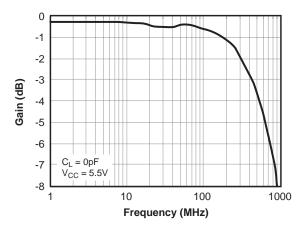
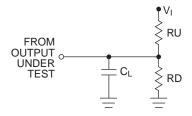


Figure 6. Bandwidth, $V_{CC} = 5.5V$

AC Loading and Waveforms



Notes:

Input driven by 50Ω source terminated in 50Ω C $_L$ includes load and stray capacitance Input PRR $\,$ = 1.0 MHz; t_W = 500 ns

Figure 7. AC Test Circuit

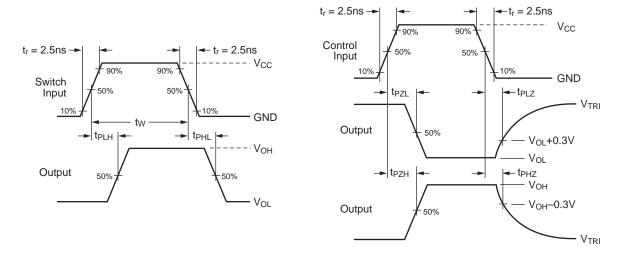


Figure 8. AC Waveforms

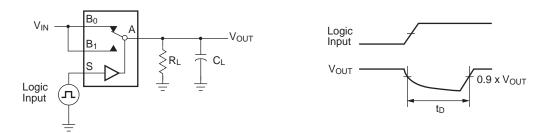


Figure 9. Break Before Make Interval Timing

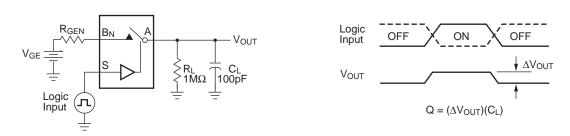


Figure 10. Charge Injection Test

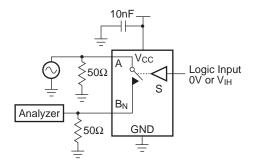


Figure 11. Off Isolation

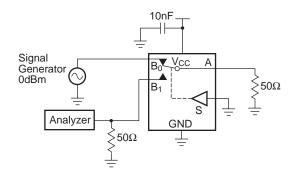


Figure 12. Crosstalk

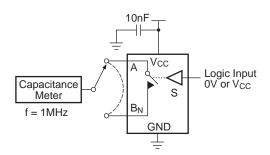


Figure 13. Channel Off Capacitance

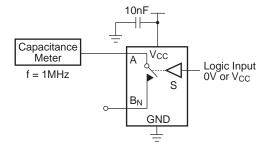


Figure 14. Channel On Capacitance

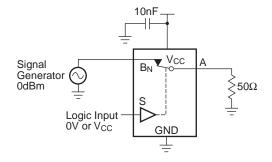


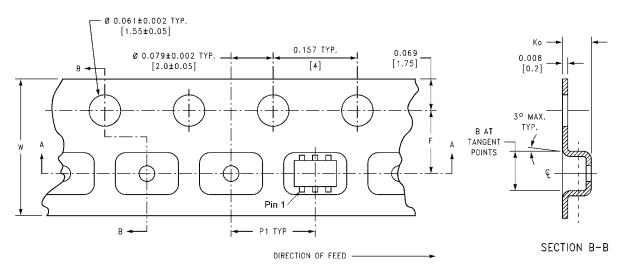
Figure 15. Bandwidth

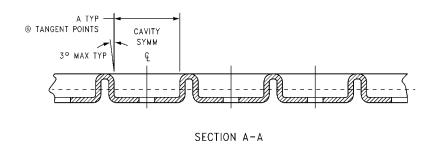
Tape and Reel Specification

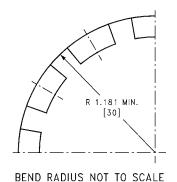
Tape Format for SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status Sealed	
P6X	Leader (Start End)	125 (typ)	Empty		
	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

Tape Dimensions inches (millimeters)





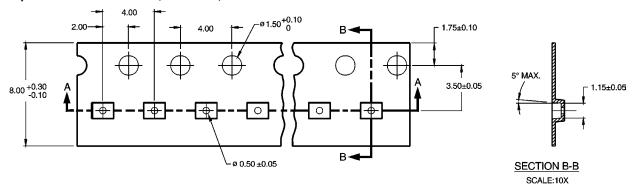


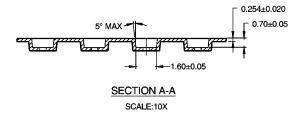
Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-6	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)

Tape Format for MicroPak

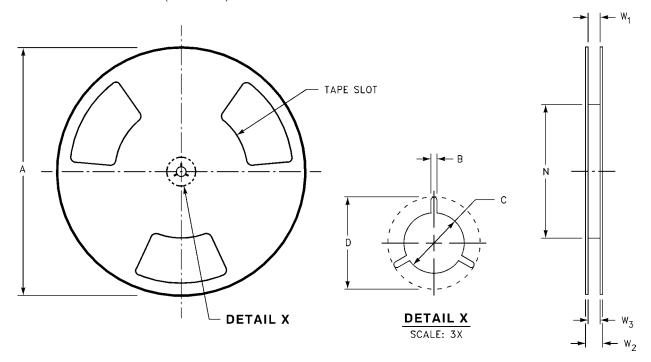
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status Sealed	
L6X	Leader (Start End)	125 (typ)	Empty		
	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

Tape Dimensions inches (millimeters)



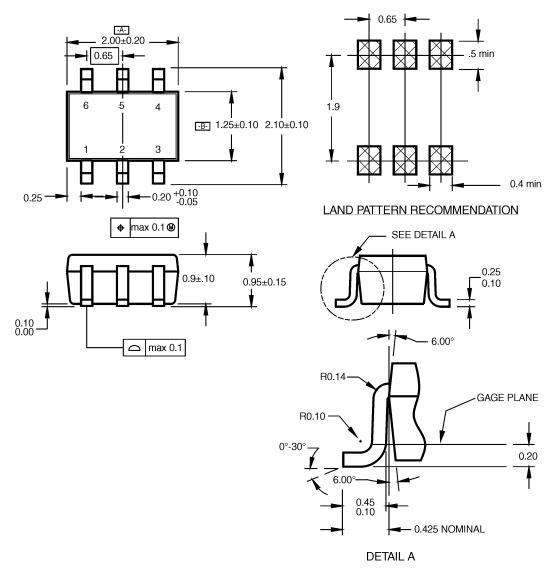


Reel Dimensions inches (millimeters)



Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted

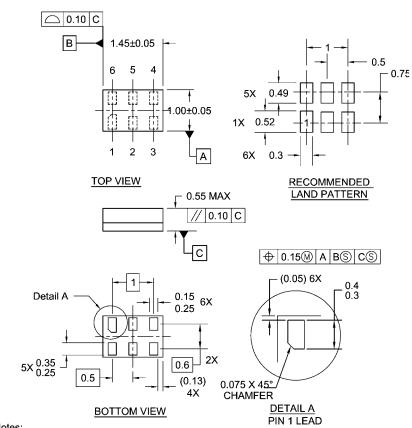


NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

MAA06ARevC



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

Pb-Free 6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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Build it Now™	FRFET™	MicroFET™	QS™	TCM™
CoolFET™	GlobalOptoisolator™	MicroPak™	QT Optoelectronics™	TinyLogic [®]
CROSSVOLT™	GTO™	MICROWIRE™	Quiet Series™	TINYOPTO™
DOME™	HiSeC™	MSX™	RapidConfigure™	TruTranslation™
EcoSPARK™	I ² C TM	MSXPro™	RapidConnect™	UHC™
E ² CMOS TM	i-Lo™	OCX TM	μSerDes™	UltraFET [®]
EnSigna™	ImpliedDisconnect™	OCXPro™	ScalarPump™	UniFET™
FACT™	IntelliMAX™	OPTOLOGIC®	SILENT SWITCHER®	VCX™
FACT Quiet Series™		OPTOPLANAR™	SMART START™	Wire™
Across the board. Around the world.™ The Power Franchise® Programmable Active Droop™		PACMAN™	SPM™	
		POP™	Stealth™	
		Power247™	SuperFET™	
		PowerEdge™	SuperSOT™-3	

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- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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Rev. I18